

# $LC^2MOS$ 5 $\Omega$ $R_{ON}$ SPST Switches

# ADG451/ADG452/ADG453

#### **FEATURES**

Low on resistance (4 Ω)
On resistance flatness (0.2 Ω)
44 V supply maximum ratings
±15 V analog signal range
Fully specified at ±5 V, 12 V, ±15 V
Ultralow power dissipation (18 μW)
ESD 2 kV
Continuous current (100 mA)
Fast switching times
t<sub>ON</sub> 70 ns
t<sub>OFF</sub> 60 ns
TTL-/CMOS-compatible
Pin-compatible upgrade for ADG411/ADG412/ADG413

and ADG431/ADG432/ADG433

#### **APPLICATIONS**

Relay replacement
Audio and video switching
Automatic test equipment
Precision data acquisition
Battery-powered systems
Sample-and-hold systems
Communication systems
PBX, PABX systems
Avionics

#### **GENERAL DESCRIPTION**

The ADG451/ADG452/ADG453 are monolithic CMOS devices comprising four independently selectable switches. They are designed on an enhanced LC<sup>2</sup>MOS process that provides low power dissipation yet gives high switching speed and low on resistance.

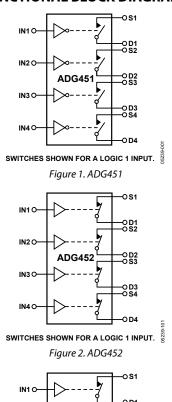
The on resistance profile is very flat over the full analog input range, ensuring excellent linearity and low distortion when switching audio signals. Fast switching speed, coupled with high signal bandwidth, makes the parts suitable for video signal switching. CMOS construction ensures ultralow power dissipation, making the parts ideally suited for portable and battery-powered instruments.

The ADG451/ADG452/ADG453 contain four independent, single-pole/single-throw (SPST) switches. The ADG451 and ADG452 differ only in that the digital control logic is inverted. The ADG451 switches are turned on with a logic low on the appropriate control input, while a logic high is required for the ADG452.

#### Rev. C

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#### **FUNCTIONAL BLOCK DIAGRAMS**



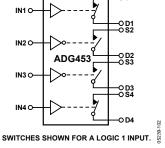


Figure 3. ADG453

The ADG453 has two switches with digital control logic similar to that of the ADG451, while the logic is inverted on the other two switches.

Each switch conducts equally well in both directions when on, and each has an input signal range that extends to the supplies. In the off condition, signal levels up to the supplies are blocked.

The ADG453 exhibits break-before-make switching action for use in multiplexer applications. Inherent in the design is low charge injection for minimum transients when switching the digital inputs.

# **TABLE OF CONTENTS**

Features
Applications
General Description
Functional Block Diagrams
Revision History
Product Highlights
Specifications
15 V Dual Supply4
12 V Single Supply5
5 V Dual Supply6
REVISION HISTORY
10/06—Rev. B to Rev. C
Changes to Table 49
Changes to Ordering Guide
12/04—Rev. A to Rev. B
Updated Format
Changes to Specifications Section
Changes to Absolute Maximum Ratings Section 8
Changes to Pin Configuration and Function
Descriptions Section
Updated Outline Dimensions
Changes to Ordering Guide

Absolute Maximum Ratings	
ESD Caution	
Pin Configuration and Function Descriptions	8
Typical Performance Characteristics	9
Terminology	11
Applications	12
Test Circuits	13
Outline Dimensions	15
Ordering Guide	16

2/98—Rev. 0 to Rev. A

10/97—Revision 0: Initial Version

### PRODUCT HIGHLIGHTS

- 1. Low  $R_{ON}$  (5  $\Omega$  maximum).
- 2. Ultralow Power Dissipation.
- 3. Extended Signal Range. The ADG451/ADG452/ADG453 are fabricated on an enhanced  $LC^2MOS$  process, giving an increased signal range that fully extends to the supply rails.
- Break-Before-Make Switching.
   This prevents channel shorting when the switches are configured as a multiplexer (ADG453 only.)

- 5. Single-Supply Operation.
  - For applications in which the analog signal is unipolar, the ADG451/ADG452/ADG453 can be operated from a single rail power supply. The parts are fully specified with a single 12 V power supply and remain functional with single supplies as low as 5.0 V.
- 6. Dual-Supply Operation.

For applications where the analog signal is bipolar, the ADG451/ADG452/ADG453 can be operated from a dual power supply ranging from  $\pm 4.5~\rm V$  to  $\pm 20~\rm V$ .

### **SPECIFICATIONS**

### **15 V DUAL SUPPLY**

 $V_{DD}$  = 15 V,  $V_{SS}$  = -15 V,  $V_{L}$  = 5 V, GND = 0 V. All specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 1.

		Version <sup>1</sup>			
Parameter	25°C	T <sub>MIN</sub> to T <sub>MAX</sub>	Unit	Test Conditions/Comments	
ANALOG SWITCH					
Analog Signal Range		$V_{\text{SS}}  to  V_{\text{DD}}$	V		
On Resistance (R <sub>ON</sub> )	4		Ω typ	$V_D = -10 \text{ V to } +10 \text{ V, } I_S = -10 \text{ mA}$	
	5	7	$\Omega$ max		
On Resistance Match Between Channels ( $\Delta R_{ON}$ )	0.1		Ω typ	$V_D = \pm 10 \text{ V, } I_S = -10 \text{ mA}$	
	0.5	0.5	$\Omega$ max		
On Resistance Flatness (R <sub>FLAT(ON)</sub> )	0.2		Ω typ	$V_D = -5 \text{ V}, 0 \text{ V}, +5 \text{ V}, I_S = -10 \text{ mA}$	
	0.5	0.5	$\Omega$ max		
LEAKAGE CURRENTS <sup>2</sup>					
Source Off Leakage, Is (OFF)	±0.02		nA typ	$V_D = \pm 10 \text{ V}, V_S = \pm 10 \text{ V}; \text{ see Figure 17}$	
	±0.5	±2.5	nA max		
Drain Off Leakage, I <sub>D</sub> (OFF)	±0.02		nA typ	$V_D = \pm 10 \text{ V}, V_S = \pm 10 \text{ V}; \text{ see Figure 17}$	
	±0.5	±2.5	nA max		
Channel On Leakage, ID, Is (ON)	±0.04		nA typ	$V_D = V_S = \pm 10 \text{ V}$ ; see Figure 18	
	±1	±5	nA max		
DIGITAL INPUTS					
Input High Voltage, V <sub>INH</sub>		2.4	V min		
Input Low Voltage, V <sub>INL</sub>		0.8	V max		
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INL}$ or $V_{INH}$ ; all others = 2.4 V or 0.8 V, respectivel	
		±0.5	μA max		
DYNAMIC CHARACTERISTICS <sup>3</sup>					
ton	70		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{pF}$ , $V_S = \pm 10 \text{V}$ ; see Figure 19	
	180	220	ns max		
toff	60		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{pF}$ , $V_S = \pm 10 \text{V}$ ; see Figure 19	
	140	180	ns max		
Break-Before-Make Time Delay, t <sub>D</sub> (ADG453 Only)	15		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_{S1} = V_{S2} = +10 V$ ; see Figure 20	
	5	5	ns min		
Charge Injection	20		pC typ	$V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1.0 \text{ nF}; \text{ see Figure 21}$	
	30		pC max		
Off Isolation	65		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 22	
Channel-to-Channel Crosstalk	-90		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 23	
C <sub>S</sub> (OFF)	37		pF typ	f = 1 MHz	
C <sub>D</sub> (OFF)	37		pF typ	f = 1 MHz	
$C_D$ , $C_S$ (ON)	140		pF typ	f = 1 MHz	
POWER REQUIREMENTS				$V_{DD} = 16.5 \text{ V}, V_{SS} = -16.5 \text{ V}; \text{ digital inputs} = 0 \text{ V or } 5 \text{ V}$	
I <sub>DD</sub>	0.0001		μA typ		
	0.5	5	μA max		
Iss	0.0001		μA typ		
	0.5	5	μA max		
IL	0.0001		μA typ		
	0.5	5	μA max		
$I_{GND}^3$	0.0001		μA typ		
	0.5	5	μA max		

 $<sup>^{1}</sup>$  Temperature range for B version is  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}.$ 

 $<sup>^{2}</sup>$  T<sub>MAX</sub> = 70°C.

 $<sup>^{\</sup>rm 3}$  Guaranteed by design, not subject to production test.

### **12 V SINGLE SUPPLY**

 $V_{DD}$  = 12 V,  $V_{SS}$  = 0 V,  $V_L$  = 5 V, GND = 0 V. All specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 2.

	B Version <sup>1</sup>				
Parameter	25°C	$T_{\text{MIN}}$ to $T_{\text{MAX}}$	Unit	Test Conditions/Comments	
ANALOG SWITCH					
Analog Signal Range		$0V$ to $V_{DD}$	V		
On Resistance (Ron)	6		Ωtyp	$V_D = 0 \text{ V to } +10 \text{ V, } I_S = -10 \text{ mA}$	
	8	10	Ω max		
On Resistance Match Between Channels (ΔR <sub>ON</sub> )	0.1		Ωtyp	$V_D = 10 \text{ V}, I_S = -10 \text{ mA}$	
	0.5	0.5	Ω max		
On Resistance Flatness (RFLAT(ON))	1.0	1.0	Ωtyp	$V_D = 0 \text{ V}, 5 \text{ V}, I_S = -10 \text{ mA}$	
LEAKAGE CURRENTS <sup>2, 3</sup>					
Source Off Leakage, Is (OFF)	±0.02		nA typ	$V_D = 0 \text{ V}$ , 10 V, $V_S = 0 \text{ V}$ , 10 V; see Figure 17	
-	±0.5	±2.5	nA max		
Drain Off Leakage, I <sub>D</sub> (OFF)	±0.02		nA typ	$V_D = 0 \text{ V}$ , 10 V, $V_S = 0 \text{ V}$ , 10 V; see Figure 17	
-	±0.5	±2.5	nA max	_	
Channel On Leakage, ID, Is (ON)	±0.04		nA typ	$V_D = V_S = 0 \text{ V}, 10 \text{ V}; \text{ see Figure 18}$	
-	±1	±5	nA max		
DIGITAL INPUTS					
Input High Voltage, VINH		2.4	V min		
Input Low Voltage, V <sub>INL</sub>		0.8	V max		
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INL}$ or $V_{INH}$	
•		±0.5	μA max		
DYNAMIC CHARACTERISTICS <sup>4</sup>					
ton	100		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_S = 8 V$ ; see Figure 19	
	220	260	ns max		
toff	80		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_S = 8 V$ ; see Figure 19	
	160	200	ns max		
Break-Before-Make Time Delay, t <sub>D</sub> (ADG453 Only)	15		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_{S1} = V_{S2} = 8 V$ ;	
,			, ,	see Figure 20	
	10	10	ns min		
Charge Injection	10		pC typ	$V_S = 6 \text{ V}, R_S = 0 \Omega, C_L = 1.0 \text{ nF}; \text{ see Figure 21}$	
Channel-to-Channel Crosstalk	-90		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 23	
C <sub>s</sub> (OFF)	60		pF typ	f = 1 MHz	
C <sub>D</sub> (OFF)	60		pF typ	f = 1 MHz	
$C_D$ , $C_S$ (ON)	100		pF typ	f = 1 MHz	
POWER REQUIREMENTS				$V_{DD} = 13.2 \text{ V}$ ; digital inputs = 0 V or 5 V	
I <sub>DD</sub>	0.0001		μA typ		
	0.5	5	μA max		
I <sub>L</sub>	0.0001		μA typ		
	0.5	5	μA max	$V_L = 5.5 \text{ V}$	
$I_{GND}^4$	0.0001		μA typ		
	0.5	5	μA max	$V_L = 5.5 \text{ V}$	

 $<sup>^1</sup>$  Temperature range for B version is  $-40^\circ\text{C}$  to +85°C.  $^2$  T<sub>MAX</sub> = 70°C.  $^3$  Tested with dual supplies.  $^4$  Guaranteed by design, not subject to production test.

#### **5 V DUAL SUPPLY**

 $V_{DD}$  = +5 V,  $V_{SS}$  = -5 V,  $V_L$  = +5 V, GND = 0 V. All specifications  $T_{MIN}$  to  $T_{MAX}$ , unless otherwise noted.

Table 3.

	В\	/ersion <sup>1</sup>		
Parameter	25°C	$T_{\text{MIN}}$ to $T_{\text{MAX}}$	Unit	Test Conditions/Comments
ANALOG SWITCH				
Analog Signal Range		$V_{\text{SS}}toV_{\text{DD}}$	V	
On Resistance (R <sub>ON</sub> )	7		Ωtyp	$V_D = -3.5 \text{ V to } +3.5 \text{ V, } I_S = -10 \text{ mA}$
	12	15	Ω max	
On Resistance Match Between Channels (ΔRon)	0.3		Ω typ	$V_D = 3.5 \text{ V, I}_S = -10 \text{ mA}$
	0.5	0.5	Ω max	
LEAKAGE CURRENTS <sup>2, 3</sup>				
Source Off Leakage, Is (OFF)	±0.02		nA typ	$V_D = \pm 4.5$ , $V_S = \pm 4.5$ ; see Figure 17
	±0.5	±2.5	nA max	
Drain Off Leakage, I <sub>D</sub> (OFF)	±0.02		nA typ	$V_D = 0 \text{ V}, 5 \text{ V}, V_S = 0 \text{ V}, 5 \text{ V}; \text{ see Figure 17}$
	±0.5	±2.5	nA max	
Channel On Leakage, ID, IS (ON)	±0.04		nA typ	$V_D = V_S = 0 \text{ V}, 5 \text{ V}; \text{ see Figure 18}$
	±1	±5	nA max	
DIGITAL INPUTS				
Input High Voltage, V <sub>INH</sub>		2.4	V min	
Input Low Voltage, V <sub>INL</sub>		0.8	V max	
Input Current, I <sub>INL</sub> or I <sub>INH</sub>	0.005		μA typ	$V_{IN} = V_{INL}$ or $V_{INH}$
		±0.5	μA max	
DYNAMIC CHARACTERISTICS <sup>4</sup>				
ton	160		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{pF}$ , $V_S = 3 \text{V}$ ; see Figure 19
	220	300	ns max	
toff	60		ns typ	$R_L = 300 \Omega$ , $C_L = 35 \text{pF}$ , $V_S = 3 \text{V}$ ; see Figure 19
	140	180	ns max	
Break-Before-Make Time Delay, t <sub>D</sub> (ADG453 Only)	50		ns typ	$R_L = 300 \Omega$ , $C_L = 35 pF$ , $V_{S1} = V_{S2} = 3 V$ ; see Figure 20
	5	5	ns min	
Charge Injection	10		pC typ	$V_S = 0 \text{ V}, R_S = 0 \Omega, C_L = 1.0 \text{ nF}; \text{ see Figure 21}$
Off Isolation	65		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 22
Channel-to-Channel Crosstalk	-76		dB typ	$R_L = 50 \Omega$ , $C_L = 5 pF$ , $f = 1 MHz$ ; see Figure 23
C <sub>s</sub> (OFF)	48		pF typ	f = 1 MHz
C <sub>D</sub> (OFF)	48		pF typ	f = 1 MHz
$C_D$ , $C_S$ (ON)	148		pF typ	f = 1 MHz
POWER REQUIREMENTS				$V_{DD} = 5.5 \text{ V}$ ; digital inputs = 0 V or 5 V
I <sub>DD</sub>	0.0001		μA typ	
	0.5	5	μA max	
Iss	0.0001		μA typ	
	0.5	5	μA max	
I <sub>L</sub>	0.0001		μA typ	
	0.5	5	μA max	$V_L = 5.5 \text{ V}$
I <sub>GND</sub> <sup>4</sup>	0.0001		μA typ	
	0.5	5	μA max	$V_L = 5.5 \text{ V}$

 $<sup>^1</sup>$  Temperature range for B version is  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ .  $^2$   $T_{\text{MAX}}=70^{\circ}\text{C}$ .  $^3$  Tested with dual supplies.  $^4$  Guaranteed by design, not subject to production test.

### **ABSOLUTE MAXIMUM RATINGS**

 $T_A = 25$ °C, unless otherwise noted.

Table 4.

Table 4.				
Parameters	Ratings			
V <sub>DD</sub> to V <sub>SS</sub>	44 V			
$V_{DD}$ to GND	−0.3 V to +32 V			
V <sub>SS</sub> to GND	+0.3 V to -32 V			
V <sub>L</sub> to GND	$-0.3 \text{ V to V}_{DD} + 0.3 \text{ V}$			
Analog, Digital Inputs <sup>1</sup>	$V_{SS} - 2V$ to $V_{DD} + 2V$ or 30 mA, whichever occurs first			
Continuous Current, S or D	100 mA			
Peak Current, S or D (pulsed at 1 ms, 10% duty cycle maximum)	300 mA			
Operating Temperature Range				
Industrial (B Version)	−40°C to +85°C			
Storage Temperature Range	−65°C to +150°C			
Junction Temperature	150°C			
Plastic DIP Package, Power Dissipation	470 mW			
$\theta_{JA}$ Thermal Impedance	117°C/W			
Lead Temperature, Soldering (10 sec)	260°C			
SOIC Package, Power Dissipation	600 mW			
$\theta_{JA}$ Thermal Impedance	77°C/W			
TSSOP Package, Power Dissipation	450 mW			
$\theta_{JA}$ Thermal Impedance	115°C/W			
$\theta_{JC}$ Thermal Impedance	35°C/W			
Lead Temperature, Soldering				
Vapor Phase (60 sec)	215°C			
Infrared (15 sec)	220°C			
ESD	2 kV			

<sup>&</sup>lt;sup>1</sup> Overvoltages at IN, S, or D are clamped by internal diodes. Current should be limited to the maximum ratings given.

Stresses above those listed under Absolute Maximum Ratings may cause permanent damage to the device. This is a stress rating only; functional operation of the device at these or any other conditions above those listed in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

Only one absolute maximum rating may be applied at any one time.

#### **ESD CAUTION**



**ESD** (electrostatic discharge) sensitive device. Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

### PIN CONFIGURATION AND FUNCTION DESCRIPTIONS

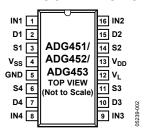


Figure 4. Pin Configuration

#### **Table 5. Pin Function Descriptions**

Pin No.	Mnemonic	Description
1	IN1	Logic Control Input.
2	D1	Drain Terminal. Can be an input or an output.
3	S1	Source Terminal. Can be an input or an output.
4	V <sub>SS</sub>	Most Negative Power Supply Potential in Dual Supplies. In single-supply applications, it can be connected to GND.
5	GND	Ground (0 V) Reference.
6	S4	Source Terminal. Can be an input or an output.
7	D4	Drain Terminal. Can be an input or an output.
8	IN4	Logic Control Input.
9	IN3	Logic Control Input.
10	D3	Drain Terminal. Can be an input or an output.
11	S3	Source Terminal. Can be an input or an output.
12	VL	Logic Power Supply (5 V).
13	$V_{DD}$	Most Positive Power Supply Potential.
14	S2	Source Terminal. Can be an input or an output.
15	D2	Drain Terminal. Can be an input or an output.
16	IN2	Logic Control Input.

### Table 6. Truth Table (ADG451/ADG452)

ADG451 In	ADG452 In	Switch Condition
0	1	On
1	0	Off

Table 7. Truth Table (ADG453)

Logic	Switch 1, Switch 4	Switch 2, Switch 3
0	Off	On
1	On	Off

### TYPICAL PERFORMANCE CHARACTERISTICS

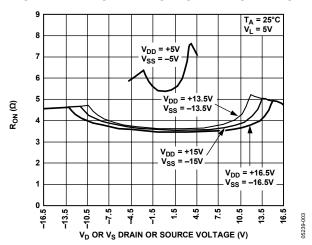


Figure 5. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Various Dual Supplies

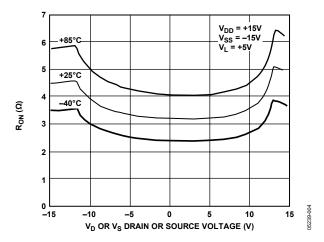


Figure 6. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures with Dual Supplies

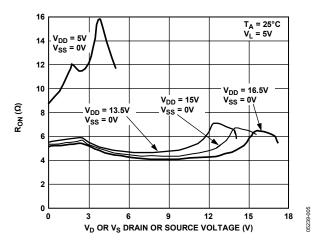


Figure 7. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Various Single Supplies

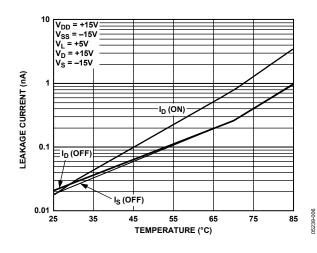


Figure 8. Leakage Currents as a Function of Temperature

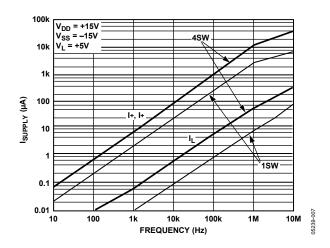


Figure 9. Supply Current vs. Input Switching Frequency

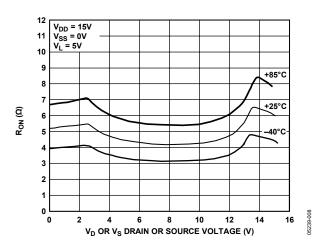


Figure 10. On Resistance as a Function of  $V_D$  ( $V_S$ ) for Different Temperatures with Single Supplies

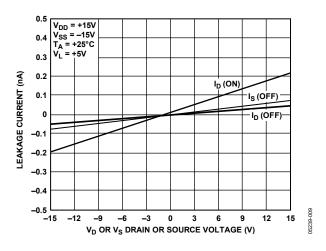


Figure 11. Leakage Currents as a Function of  $V_D$  ( $V_S$ )

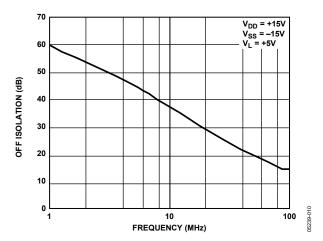


Figure 12. Off Isolation vs. Frequency

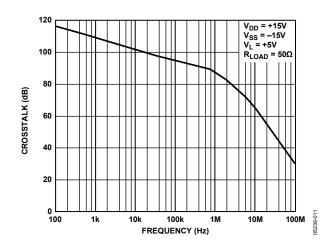


Figure 13. Crosstalk vs. Frequency

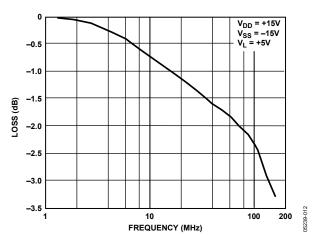


Figure 14. Frequency Response with Switch On

### **TERMINOLOGY**

#### Ron

Ohmic resistance between D and S.

#### $\Delta R_{ON}$

On resistance match between any two channels, that is,  $R_{\rm ON}$  maximum minus  $R_{\rm ON}$  minimum.

#### $R_{\text{FLAT(ON)}}$

Flatness is defined as the difference between the maximum and minimum value of on resistance, as measured over the specified analog signal range.

#### Is (OFF)

Source leakage current with the switch off.

#### I<sub>D</sub> (OFF)

Drain leakage current with the switch off.

#### ID, Is (ON)

Channel leakage current with the switch on.

#### $V_D(V_S)$

Analog voltage on Terminal D and Terminal S.

#### Cs (OFF)

Off switch source capacitance.

#### C<sub>D</sub> (OFF)

Off switch drain capacitance.

#### $C_D$ (ON), $C_S$ (ON)

On switch capacitance.

#### tox

Delay between applying the digital control input and the output switching on. See Figure 19.

#### toff

Delay between applying the digital control input and the output switching off.

#### $\mathbf{t}_{\mathrm{I}}$

Off time or on time measured between the 90% points of both switches, when switching from one address state to another. See Figure 20.

#### Crosstalk

A measure of unwanted signal coupled through from one channel to another as a result of parasitic capacitance.

#### **Off Isolation**

A measure of unwanted signal coupling through an off switch.

#### **Charge Injection**

A measure of the glitch impulse transferred from the digital input to the analog output during switching.

### **APPLICATIONS**

Figure 15 illustrates a precise, fast, sample-and-hold circuit. An AD845 is used as the input buffer, and the output operational amplifier is an AD711. During track mode, SW1 is closed, and the output,  $V_{\text{OUT}}$ , follows the input signal,  $V_{\text{IN}}$ . In hold mode, SW1 is opened, and the signal is held by the hold capacitor,  $C_{\text{H}}$ .

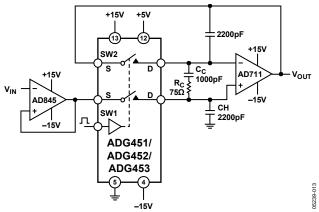


Figure 15. Fast, Accurate Sample-and-Hold Circuit

Due to switch and capacitor leakage, the voltage on the hold capacitor decreases with time. The ADG451/ADG452/ADG453 minimize this droop due to their low leakage specifications. The droop rate is further minimized by the use of a polystyrene hold capacitor. The droop rate for the circuit shown is typically 30  $\mu V/\mu s.$ 

A second switch, SW2, which operates in parallel with SW1, is included in this circuit to reduce pedestal error. Because both switches are at the same potential, they have a differential effect on the op amp, AD711, which minimizes charge injection effects. Pedestal error is also reduced by the compensation network,  $R_{\rm C}$  and  $C_{\rm C}$ . This compensation network reduces the hold time glitch while optimizing the acquisition time. Using the illustrated op amps and component values, the pedestal error has a maximum value of 5 mV over the  $\pm 10$  V input range. Both the acquisition and settling times are 850 ns.

### **TEST CIRCUITS**

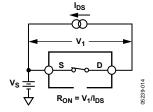


Figure 16. On Resistance

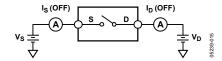


Figure 17. Off Leakage

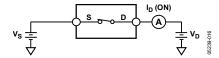


Figure 18. On Leakage

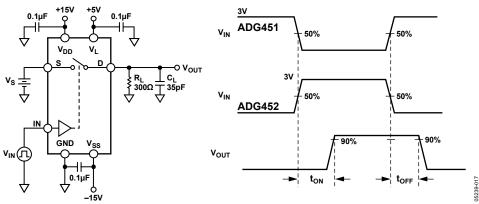
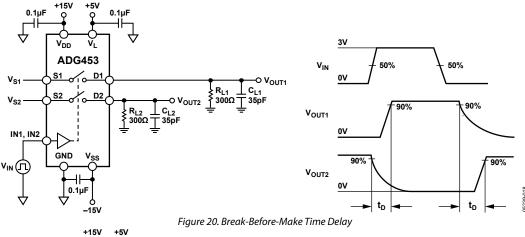


Figure 19. Switching Times



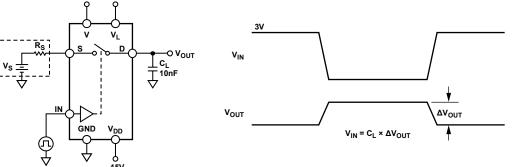


Figure 21. Charge Injection

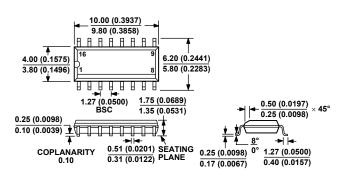
Figure 22. Off Isolation

$$V_{\text{OUT}} = \frac{15V}{V_{\text{DD}}} = \frac{50\Omega}{V_{\text{IN}10}} = \frac{50\Omega}{V_{\text{IN}2}} = \frac{50\Omega}{V_{\text{IN}$$

Figure 23. Channel-to-Channel Crosstalk

Rev. C | Page 14 of 16

### **OUTLINE DIMENSIONS**



#### COMPLIANT TO JEDEC STANDARDS MS-012-AC

CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 24. 16-Lead Standard Small Outline Package [SOIC\_N] Narrow Body (R-16)

Dimensions shown in millimeters and (inches)

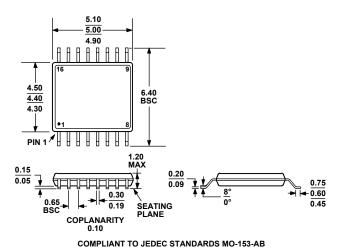
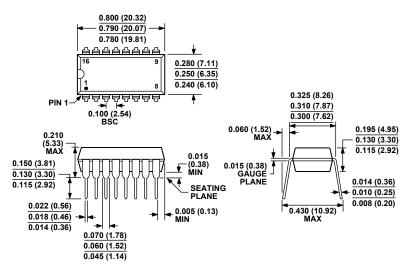


Figure 25. 16-Lead Thin Shrink Small Outline Package [TSSOP] (RU-16) Dimensions shown in millimeters



#### COMPLIANT TO JEDEC STANDARDS MS-001-AB

CONTROLLING DIMENSIONS ARE IN INCHES; MILLIMETER DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF INCH EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN. CORNER LEADS MAY BE CONFIGURED AS WHOLE OR HALF LEADS.

Figure 26. 16-Lead Plastic Dual In-Line Package [PDIP]
Narrow Body
(N-16)
Dimensions shown in inches and (millimeters)

#### **ORDERING GUIDE**

Model	Temperature Range	Package Description	Package Option
ADG451BN	−40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG451BNZ <sup>1</sup>	-40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG451BR	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BR-REEL	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BR-REEL7	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BRZ <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BRZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BRZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG451BRUZ <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG451BRUZ- REEL <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG451BRUZ- REEL71	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG451BCHIPS		DIE	
ADG452BN	-40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG452BNZ <sup>1</sup>	-40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG452BR	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BR-REEL	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BR-REEL7	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BRZ <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BRZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BRZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG452BRUZ <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG452BRUZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG452BRUZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG453BN	-40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG453BNZ <sup>1</sup>	-40°C to +85°C	16-Lead Plastic Dual In-Line Package [PDIP]	N-16
ADG453BR	−40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BR-REEL	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BR-REEL7	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BRZ <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BRZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BRZ-REEL7 <sup>1</sup>	-40°C to +85°C	16-Lead Standard Small Outline Package [SOIC_N]	R-16
ADG453BRUZ <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG453BRUZ-REEL <sup>1</sup>	-40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16
ADG453BRUZ-REEL71	−40°C to +85°C	16-Lead Thin Shrink Small Outline Package [TSSOP]	RU-16

<sup>&</sup>lt;sup>1</sup> Z = Pb-free part.



# **Mouser Electronics**

**Authorized Distributor** 

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### **Analog Devices Inc.:**

ADG453BRZ-REEL7 ADG451BRZ-REEL ADG452BRZ-REEL ADG452BRUZ ADG451BRZ-REEL7 ADG453BRUZ-REEL7 ADG451BN ADG451BR-REEL ADG453BR-REEL7 ADG452BRZ ADG451BRUZ-REEL ADG453BRZ-REEL ADG453BRZ-REEL7 ADG453BRZ ADG451BR ADG451BRZ ADG452BRUZ-REEL7 ADG453BR ADG451BR-REEL7 ADG453BRUZ-REEL ADG451BRUZ-REEL7 ADG451BRUZ-REEL7 ADG451BRUZ-REEL7 ADG451BRUZ-REEL7 ADG452BRUZ-REEL7 ADG452B